

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	MORDECHAY PINCHAS FREIMAN	10/04/2018
	LIRAN GOSHEN	10/04/2018
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Postal Code:	5656 AE	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16497026
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NAME OF SUBMITTER:	NOEMI CHAPA	
SIGNATURE:	/Noemi Chapa/	
DATE SIGNED:	09/24/2019	
Total Attachments: 2		
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source=2017P01580WOUS_DEC_ASSIGNMENT_#page2.tif		

For good and valuable consideration, of which I/we acknowledge receipt, I/we as a below-named Assignor(s) or Inventor, hereby sell, and assign, and transfer the entire and exclusive right, title, and interest in the following to Koninklijke Philips N.V., having a place of business at High Tech Campus 5, 5656 AE, Eindhoven, the Netherlands, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee") my/our invention for which an application:

☐ is executed concurrently herewith

☐ was filed on ***, having a United States Application No. ***

☒ was filed on **2018-Mar-20**, having an International Application No. **PCT/EP2018/057025**,

and all rights in and to said application, and all other United States, foreign and international patent applications associated therewith, based thereon, or claiming priority therefrom including, but not limited to, any and all provisionals, non-provisionals divisions, continuations, continuations-in-part, re-examinations, reissues, and extensions thereof, and the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

I/We authorize and request that the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to the Assignee(s), for its sole use, and that of its successors, assigns, and legal representatives.

I/We will provide my/our cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, I/we agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecution actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

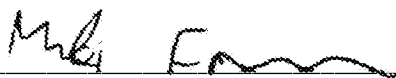
I/We certify that I/we have the full right to convey the above rights.

As a below-named Inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original Inventor or an original joint Inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Date: 2018-Oct-04

Signature: _____


Mordechay Pinchas FREIMAN

Assignor/Inventor

Date: _____

Signature: _____

Liran GOSHEN

Assignor/Inventor

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☐ is executed concurrently herewith

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and all rights in and to said application, and all other United States, foreign and international patent applications associated therewith, based thereon, or claiming priority therefrom including, but not limited to, any and all provisionals, non-provisionals divisions, continuations, continuations-in-part, re-examinations, reissues, and extensions thereof, and the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

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Date: _____

Signature: _____,

Assignor/Inventor

Date: 4-05-2018

Signature: Liran Goshen

Assignor/Inventor

Liran GOSHEN